<u>MOSFET</u> – Single, N-Channel 60 V, 2.5 mΩ, 155 A

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	60	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain Cur-	Steady State	$T_C = 25^{\circ}C$	Ι _D	155	А
rent $R_{\theta JC}$ (Notes 1 & 3)		$T_{C} = 100^{\circ}C$		110	
Power Dissipation $R_{\theta JC}$		$T_{C} = 25^{\circ}C$	PD	115	W
(Note 1)		$T_{C} = 100^{\circ}C$		58	
Continuous Drain		$T_A = 25^{\circ}C$	I _D	29	А
Current R _{θJA} (Notes 1, 2 & 3)	Steady	$T_A = 100^{\circ}C$		21	
Power Dissipation $R_{\theta JA}$	State	$T_A = 25^{\circ}C$	PD	4	W
(Notes 1 & 2)		T _A = 100°C		2	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	900	А
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 175	°C
Source Current (Body Diode)			I _S	96	А
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 14.4 A)			E _{AS}	363	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

MAXIMUM RATINGS (T_{.1} = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain) (Note 1)	$R_{\theta JC}$	1.3	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	37	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

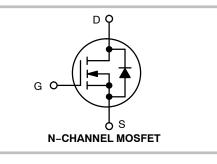
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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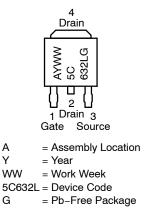
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V _{(BR)DSS}	R _{DS(on)}	ID
60 V	$2.5~\mathrm{m}\Omega$ @ 10 V	155 A
00 V	3.4 mΩ @ 4.5 V	135 A





MARKING DIAGRAM & PIN ASSIGNMENT



ORDERING INFORMATION

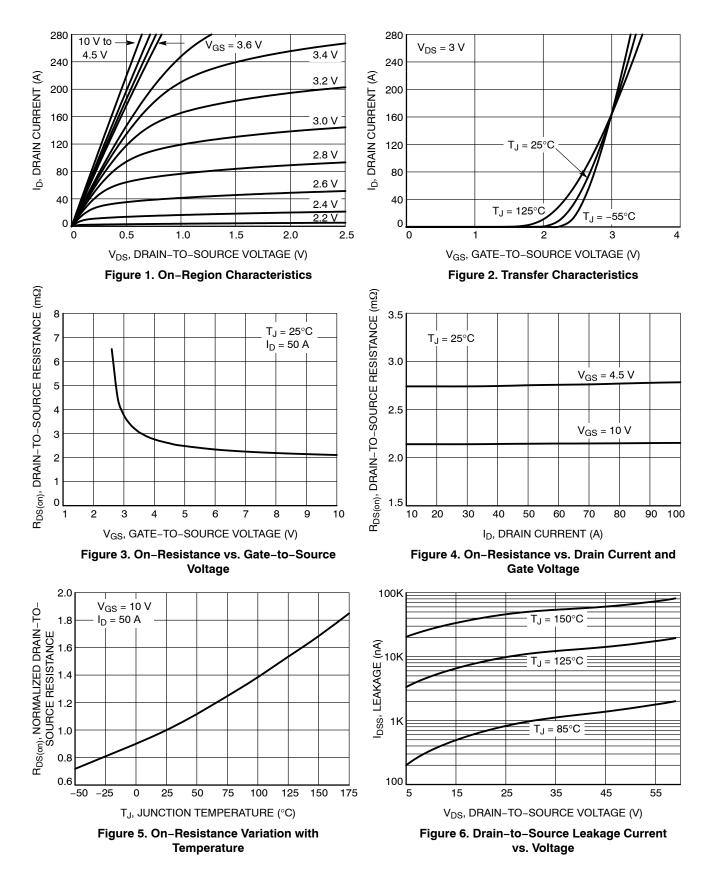
See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

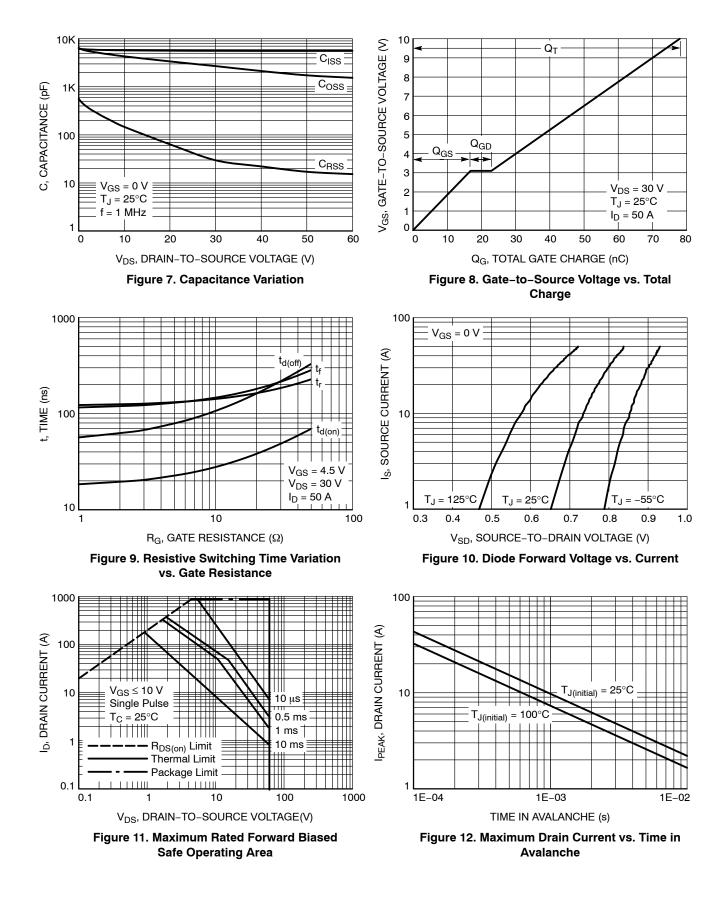
Parameter	Symbol	Symbol Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				24		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 60 V	T _J = 25°C			10	μA
			T _J = 125°C			250	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{G}$	_S = 20 V			100	nA
ON CHARACTERISTICS (Note 4)	•				•		-
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μA	1.2		2.1	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				5.8		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _E	₀ = 50 A		2.1	2.5	mΩ
		V _{GS} = 4.5 V, I _I	_D = 50 A		2.7	3.4	
Forward Transconductance	9fs	$V_{DS} = 3 V, I_D$	= 50 A		185		S
CHARGES, CAPACITANCES AND GATE RE	SISTANCES				•		-
Input Capacitance	C _{iss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 25 V			5700		pF
Output Capacitance	C _{oss}				2800		
Reverse Transfer Capacitance	C _{rss}				36		
Total Gate Charge	Q _{G(TOT)}	$V_{DS} = 30 V,$ $I_{D} = 50 A$	V _{GS} = 4.5 V		34		nC
			V _{GS} = 10 V		78		-
Total Gate Charge	Q _{G(TOT)}				34.0		nC
Threshold Gate Charge	Q _{G(TH)}				9.5		1
Gate-to-Source Charge	Q _{GS}	$V_{\rm GS}$ = 4.5 V, $V_{\rm DS}$ = 30 V, $I_{\rm D}$ = 50 A			16.8		-
Gate-to-Drain Charge	Q _{GD}				6.1		-
Plateau Voltage	V _{GP}				3.1		V
Gate Resistance	R _G				0.7		Ω
SWITCHING CHARACTERISTICS (Note 5)			1		•		
Turn-On Delay Time	t _{d(on)}				20		ns
Rise Time	t _r	V _{GS} = 4.5 V, V _I	$h_{0} = 30 V_{0}$		126		
Turn-Off Delay Time	t _{d(off)}	$V_{GS} = 4.0 \text{ V}, V_{DS} = 30 \text{ V},$ $I_D = 50 \text{ A}, \text{ R}_G = 2.5 \Omega$			65		1
Fall Time	t _f				121		
DRAIN-SOURCE DIODE CHARACTERISTIC	S				•		•
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$ $I_{S} = 50 A$	$T_J = 25^{\circ}C$		0.8	1.2	V
			T _J = 125°C		0.7		1
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/μs, I _S = 50 A			71		ns
Charge Time	ta				36		1
Discharge Time	tb				36		1
Reverse Recovery Charge	Q _{RR}				110		nC

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

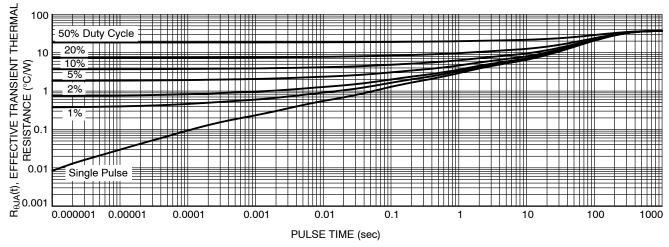


Figure 13. Thermal Response

ORDERING INFORMATION

Order Number	Order Number Package Shipping [†]			
NTD5C632NLT4G	DPAK (Pb–Free)	2500 / Tape & Reel		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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